



Docket No.: M4065.0239/P239  
(PATENT)

**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

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In re Patent Application of:  
Larry Hillyer et al.

Application No.: 09/653,561

Art Unit: 2812

Filed: August 31, 2000

Examiner: Ha T. Nguyen

For: METHOD AND MATERIAL FOR  
REMOVING ETCH RESIDUE FROM HIGH  
ASPECT RATIO CONTACT SURFACES

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**AMENDMENT TO NON-FINAL OFFICE ACTION**

MS Amendment  
Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

Dear Sir:

**INTRODUCTORY COMMENTS**

In response to the Office Action mailed June 6, 2005, please amend the above-identified U.S. patent application as follows:

**Amendments to the Claims** are reflected in the listing of claims which begins on page 2 of this paper.

**Remarks** begin on page 17 of this paper.